

Docket No.: 4425-345



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Joseph SUN et al.

U.S. Patent Application No. 10/764,469

Filed: January 27, 2004

:  
:  
Confirmation No. 1145  
:  
Group Art Unit: 2814  
:  
Examiner: MURSALIN B HAFIZ

For: PACKAGE OF A SEMICONDUCTOR DEVICE WITH A FLEXIBLE WIRING SUBSTRATE AND METHOD FOR THE SAME

Dear Sir:

Transmitted herewith is an Amendment in the above identified application.

- ☒ No additional fee is required.  
☐ Small entity status of this application has been established.  
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	1	3		x \$ 50 =	\$ 0.00
Independent Claims	12	20		x \$200 =	\$ 0.00
If multiple claims newly presented, add \$360.00					
Fee for extension of time					
TOTAL FEE DUE					\$ 0.00

- ☐ A credit card authorization form in the amount of \_\_\_\_\_ is attached
- ☒ The Commissioner is hereby authorized to charge payment of any *deficiency* in fees associated with this communication or credit any overpayment, to Deposit Account No. 07-1337, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,  
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Date: December 30, 2005



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SUBSTRATE AND METHOD FOR THE SAME

AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Official Action mailed on September 30, 2005, please  
amend the above-identified patent application as follows: